

# ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Page 1 of 2

## Title of Invention

Adapter Board for Stacking Ball-Grid-Array (BGA) chips

Application Number :

Confirmation Number:

First Named Applicant: Yao Yen

Attorney Docket Number: PS-108

Art Unit:

Examiner:

Search string: ( 6587393 or 6576992 or 6461895 or 6414381 or 6339254 or 6157080 or 5910010 or 5744827 or 20030107118 or 20030081392 or 20030001288 ).pn

## US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
<i>BN</i>	1	6587393	2003-07-01	Ayukawa , et al.	B1	365	230.03
<i>BN</i>	2	6576992	2003-06-10	Cady , et al.	B1	257	686
<i>BN</i>	3	6461895	2002-10-08	Liang , et al.	B1	438	107
<i>BN</i>	4	6414381	2002-07-02	Takeda	B1	257	676
<i>BN</i>	5	6339254	2002-01-15	Venkateshwaran , et al. January 15, 2002	B1	257	686
<i>BN</i>	6	6157080	2000-12-05	Tamaki , et al.	B1	257	738
<i>BN</i>	7	5910010	1999-06-08	Nishizawa , et al.	B1	438	15
<i>BN</i>	8	5744827	1998-04-28	Jeong , et al.	B1	257	686

## US Published Applications

Note: Applicant is not required to submit a paper copy of cited US Published Applications

init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
<i>BN</i>	1	20030107118	2003-06-12	Pflughaupt, L. Elliott ; et al.	A1	257	686
<i>BN</i>	2	20030081392	2003-05-01	Cady, James W. ; et al.	A1	361	767
<i>BN</i>	3	20030001288	2003-01-02	Tay, Wu Yean ; et al.	A1	257	780

Paper No. 0204

Signature

Page 2 of 2

Examiner Name	Date
John B. Vignone	March 19, 2006

Paper No. 0204